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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/044,686	01/11/2002	Shiro Sakai	08228/019001	9706
22511	7590	09/09/2005	EXAMINER	
OSHA LIANG L.L.P. 1221 MCKINNEY STREET SUITE 2800 HOUSTON, TX 77010			SONG, MATTHEW J	
			ART UNIT	PAPER NUMBER
			1722	

DATE MAILED: 09/09/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary	Application No. 10/044,686	Applicant(s) SAKAI ET AL.	
	Examiner Matthew J. Song	Art Unit 1722	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 26 July 2005.
- 2a) ☐ This action is **FINAL**. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-6 and 12-16 is/are pending in the application.
- 4a) Of the above claim(s) _____ is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 1-6 and 12-16 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on _____ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some * c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
2. ☐ Certified copies of the priority documents have been received in Application No. _____.
3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- | | |
|--|---|
| 1) <input checked="" type="checkbox"/> Notice of References Cited (PTO-892) | 4) <input type="checkbox"/> Interview Summary (PTO-413)
Paper No(s)/Mail Date. _____ |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948) | 5) <input type="checkbox"/> Notice of Informal Patent Application (PTO-152) |
| 3) <input checked="" type="checkbox"/> Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)
Paper No(s)/Mail Date <u>7/26/05</u> . | 6) <input type="checkbox"/> Other: _____ |

DETAILED ACTION

Allowable Subject Matter

1. Applicant is advised that the Notice of Allowance mailed 5/26/2005 is vacated. If the issue fee has already been paid, applicant may request a refund or request that the fee be credited to a deposit account. However, applicant may wait until the application is either found allowable or held abandoned. If allowed, upon receipt of a new Notice of Allowance, applicant may request that the previously submitted issue fee be applied. If abandoned, applicant may request refund or credit to a specified Deposit Account.

2. Prosecution on the merits of this application is reopened on claims 1-6 and 12-16 considered unpatentable for the reasons indicated below:

Claim Rejections - 35 USC § 112

3. The following is a quotation of the first paragraph of 35 U.S.C. 112:

The specification shall contain a written description of the invention, and of the manner and process of making and using it, in such full, clear, concise, and exact terms as to enable any person skilled in the art to which it pertains, or with which it is most nearly connected, to make and use the same and shall set forth the best mode contemplated by the inventor of carrying out his invention.

4. Claim 1 is rejected under 35 U.S.C. 112, first paragraph, as failing to comply with the written description requirement. The claim(s) contains subject matter, which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention. Claim 1 recites in the last four lines, "forming a light emitting section on a central section of the nitride

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semiconductor chip and forming an electrode at opposing ends of a planar surface of a nitride semiconductor chip". There is no support for the forming electrodes at opposing ends of a planar surface of the nitride semiconductor chip. The instant specification does not teach any planar surface nor does the specification teach forming electrodes at opposing ends. Fig 3B shows the electrodes on different planes, so the electrodes are no different planar surfaces.

Claim Rejections - 35 USC § 103

5. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

6. Claims 1-6 and 12-16 are rejected under 35 U.S.C. 103(a) as being unpatentable over Motoki et al (EP 0961328 A2) or Shakuda et al (JP 10-275933), where an English Abstract and computer translation (CT) have been provided, in view of Applicant's Admitted Prior Art (AAPA).

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In a method of manufacturing a nitride semiconductor chip, note entire reference, Motoki et al teaches a GaN/GaN LED has a shape of an equilateral rhombus (Abstract) and scribing by cutting lines 24, 24, and cutting lines 25, 25..... which are at an angle of 120° with the cutting lines 25 ([0052] and Fig 18, this reads on applicant's cutting the substrate along two directions that form a 120° angle. Motoki et al also teaches forming GaN, which has hexagonal symmetry, and grown as a regular hexagon on a substrate ([0019]-[0020]), this reads on applicant's growing nitride crystals of a hexagonal system on a surface of a substrate.

In a method of forming a light emitting element, Shakuda et al teaches a semiconductor lamination part 10 of GaN, a first p-type electrode 8, and a second n-type electrode 9, where the electrodes are formed in opposite corners of a rhombus shaped chip (Abstract and Fig 1b). Shakuda et al teaches the electrodes are placed on corners of the chip, as applicants, note Fig 3A and 3B; therefore reads on applicant's forming electrodes at opposing ends of a planar surface. Shakuda et al also teaches a line is put in with a diamond pen and the chip is obtained by dividing and the acute angle of the rhombus is 60° (CT [0014]). Shakuda et al teaches an acute angle of 60° ; therefore by simply geometry, the obtuse angle must be 120° since the opposite angles are the same and the sides of the rhombus are all equal. Therefore, Shakuda et al inherently teaches cutting the substrate along two direction that form an angle of 120° . Also, note Mushika et al (US 2005/0168798), which teaches 60° angles at acute vertexes and 120° for obtuse vertexes for a rhombus ([0156]), which supports the Examiner's position of inherency. Shakuda et al also teaches a sapphire substrate ([0013]) and the rhombus configuration allows cutting without cracking, when carrying out separation from a wafer at each chip ([0021]).

Motoki et al and Shakuda et al do not teach grinding a back surface of the substrate.

In a method of forming GaN LEDs, AAPA teaches GaN crystals having a hexagonal system are grown on a sapphire substrate and after the crystals are grown the substrate is cut into chips for use as devices such as light emitting diodes. AAPA also teaches the back surface of the substrate is first ground and then scratches are made on the front or back side of the substrate using a diamond pen or the like. After the substrate is ground to the desired thickness, the substrate is cut along the direction of the scratches. The process of grinding the substrate is performed so that the substrate will easily split (page 1-2 of the specification).

It would have been obvious to a person of ordinary skill in the art at the time of the invention to modify Motoki et al or Shakuda et al by grinding the back of the substrate and scratching to easily split the substrate, as taught by AAPA.

Referring to claim 1, the combination of Motoki et al and AAPA teaches a p-electrode at a top portion of a LED, an n-electrode on the opposite side, on a bottom portion of an LED and a light emitting section in the middle 19, this reads on applicant's forming a light emitting section on a central section of the nitride semiconductor chip and forming an electrode at opposing ends of a planar surface of the nitride semiconductor because the thickness of the chip would read on the planar surface and the electrodes are on opposite side of that plane.

Referring to claims 2, 3 and 13, the combination of Motoki et al and AAPA teaches scratching the front or back of the substrate (AAPA, Page 1 of the instant specification).

Referring to claims 4 and 14, the combination of Motoki et al and AAPA teaches an equilateral rhombus ('328 Abstract, col 9, ln 5-15 and claim 4).

Referring to claims 5 and 15, the combination of Motoki et al and AAPA teaches sapphire (AAPA page 1 and '328 [0005]).

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Referring to claims 6 and 16, the combination of Motoki et al and AAPA teaches GaN ('328 Abstract).

Conclusion

7. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Matthew J. Song whose telephone number is 571-272-1468. The examiner can normally be reached on M-F 9:00-5:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Duane Smith can be reached on 571-272-1166. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Matthew J Song
Examiner
Art Unit 1722

MJS
August 31, 2005

DUANE SMITH
PRIMARY EXAMINER

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9-6-05